

STTH108

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High voltage ultrafast rectifier

Features

- Low forward voltage drop
- High reliability
- High surge current capability
- Soft switching for reduced EMI disturbances
- Planar technology

Description

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The STTH108, which is using ST ultrafast high voltage planar technology, is specially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications.

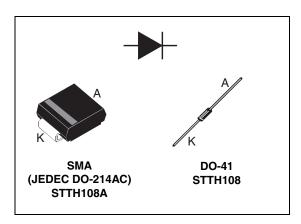


Table 1. Device summary

Symbol	Value
I _{F(AV)}	1 A
V_{RRM}	800 V
T _j (max)	175 °C
V _F (max)	1.25 V

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Characteristics STTH108

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol		Value	Unit			
V _{RRM}	Repetitive peak reverse volt	age			800	V
V _(RMS)	Voltage rms				560	V
1	A core se femoral comment		T _L = 110 °C	δ = 0.5	1	Α
I _{F(AV)}	Average forward current	DO-41	T _L = 130 °C	$\delta = 0.5$	ı	Α
	SMA SMA		SMA	20	Α	
I _{FSM} Forward Surge current		t = 8.3 ms		25	A	
T _{stg}	Storage temperature range			-50 to + 175	°C	
T _j	Maximum operating junction temperature				175	°C

Table 3. Thermal resistance

Symbol		Parameter			
В	Junction to lead		SMA	30	
R _{th(j-l)} Junction to lead		Lead length = 10 mm	DO-41	45	°C/W
R _{th(j-a)}	Junction to ambient	Lead length = 10 mm	DO-41	110	

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
1_	Reverse leakage	T _j = 25 °C	V _R = 800 V			5	μA
IR current	T _j = 125 °C	v _R = 000 v		1	50	μΛ	
V _F	Forward voltage drop	T _j = 25 °C				1.65	V
V _F Forward voltage drop	T _j = 125 °C	IIF – I A		0.89	1.25	V	

To evaluate the conduction losses use the following equation: P = 1.05 x $I_{F(AV)}$ + 0.20 $I_{F^2(RMS)}$

Table 5. Dynamic electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I _F = 0.5 A, I _{rr} = 0.25 A I _R = 1 A			75	ns
t _{fr}	Forward recovery time	T _j = 25 °C	$I_F = 1 A$, $dI_F/dt = 50 A/ms$ $V_{FR} = 1.1 x V_F max$			200	ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	I _F = 1 A, dI _F /dt = 50 A/ms			12	V

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Figure 1. Conduction losses versus average Figure 2. Forward voltage drop versus current forward current

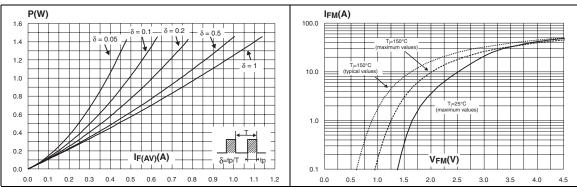


Figure 3. Relative variation of thermal impedance junction ambient versus pulse duration (DO-41)

Figure 4. Relative variation of thermal impedance junction ambient versus pulse duration (epoxy FR4) (SMA)

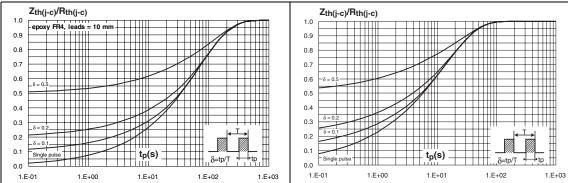
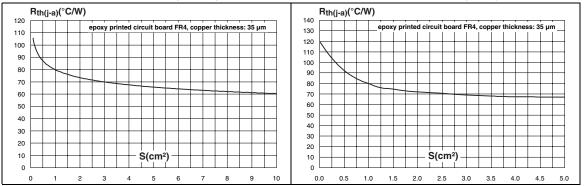


Figure 5. Thermal resistance junction to ambient versus copper surface under each lead (DO-41)

Figure 6. Thermal resistance junction to ambient versus copper surface under each lead (SMA)



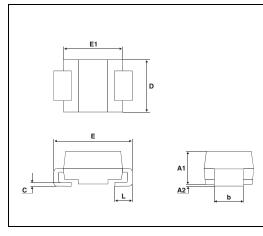
Package information STTH108

2 Package information

- Epoxy meets UL 94, V0
- Band indicates cathode
- Bending method (DO-41): see Application note AN1471

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 6. SMA dimensions



		Dimensions				
Ref.	Millin	neters	Inc	hes		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.075	0.094		
A2	0.05	0.20	0.002	0.008		
b	1.25	1.65	0.049	0.065		
С	0.15	0.40	0.006	0.016		
D	2.25	2.90	0.089	0.114		
Е	4.80	5.35	0.189	0.211		
E1	3.95	4.60	0.156	0.181		
L	0.75	1.50	0.030	0.059		

Figure 7. Footprint (dimensions in mm)

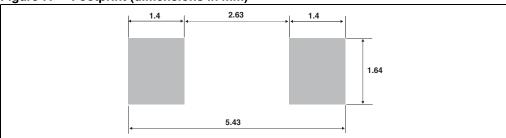
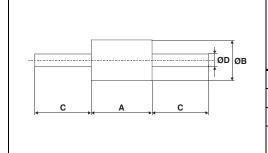


Table 7. DO-41 (plastic) package dimensions



	Dimensions				
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.07	5.20	0.160	0.205	
В	2.04	2.71	0.080	0.107	
С	25.4		1		
D	0.71	0.86	0.028	0.034	

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STTH108 Ordering information

3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH108	STTH108	DO-41	0.34 g	2000	Ammopack
STTH108A	H08	SMA	0.068 g	5000	Tape and reel
STTH108RL	STTH108	DO-41	0.34 g	5000	Tape and reel

4 Revision history

Table 9. Document revision history

Date	Revision	Changes	
Jan-2003	2	Last update.	
30-Sep-2009	3	Updated table 7 package dimensions.	

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